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(12) **United States Design Patent**
Li

(10) **Patent No.:** **US D704,180 S**

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(54) **COVER OF AN ELECTRONIC DEVICE
HAVING SURFACE ORNAMENTATION**

(75) Inventor: **Bin Li**, Shenzhen (CN)

(73) Assignee: **FIH (Hong Kong) Limited**, Kowloon
(HK)

(**) Term: **14 Years**

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(30) **Foreign Application Priority Data**

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(51) **LOC (10) Cl.** **14-03**

(52) **U.S. Cl.**
USPC **D14/248**

(58) **Field of Classification Search**

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D14/172, 203, 217, 218, 238.1, 240, 247,
D14/248, 250, 251, 253, 299, 341, 342, 344,
D14/345, 346, 347, 439, 440, 496; D5/53,
D5/55, 56, 59, 61, 63; D3/201, 248, 269,
D3/273, 301, 303; 206/320

See application file for complete search history.

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Primary Examiner — Thomas Johannes

Assistant Examiner — Chelsea Sealey

(74) *Attorney, Agent, or Firm* — Novak Druce Connolly
Bove + Quigg LLP

(57) **CLAIM**

The ornamental design for a cover of an electronic device
having surface ornamentation, as shown and described.

DESCRIPTION

The present application is related to co-pending U.S. patent
applications Ser. Nos. 29/425,170, 29/425,172, 29/425,437
and 29/425,438, each, entitled “Cover of an Electronic
Device Having Surface Ornamentation”, by Bin Li. These
applications have the same assignee as the present application
and have been concurrently filed herewith. The above-ident-
ified applications are incorporated herein by reference.

FIG. 1 is a perspective view of a cover of an electronic device
having surface ornamentation showing my new design;

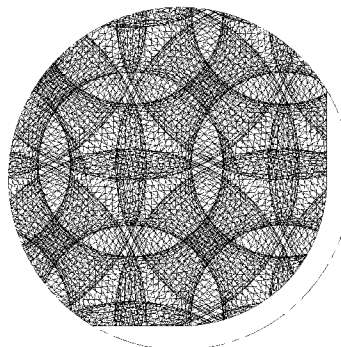
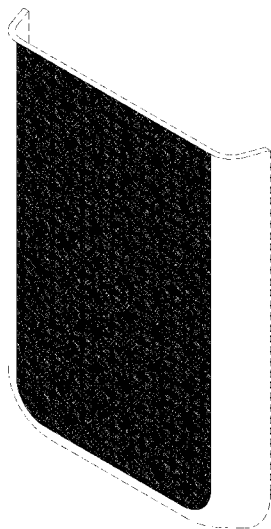
FIG. 2 is a front elevational view thereof;

FIG. 3 is a side elevational view thereof; and,

FIG. 4 is an enlarged fragmentary view thereof showing
circled portion 4 in FIG. 2.

In FIG. 1-3, the evenly segmented broken lines indicate por-
tions of the cover of an electronic device having surface
ornamentation that form no part of the claimed design. In
FIGS. 2 and 4, the unevenly segmented broken lines indicate
the portion of the design that is shown on an enlarged scale in
FIG. 4. The broken lines form no part of the claimed design.

1 Claim, 4 Drawing Sheets



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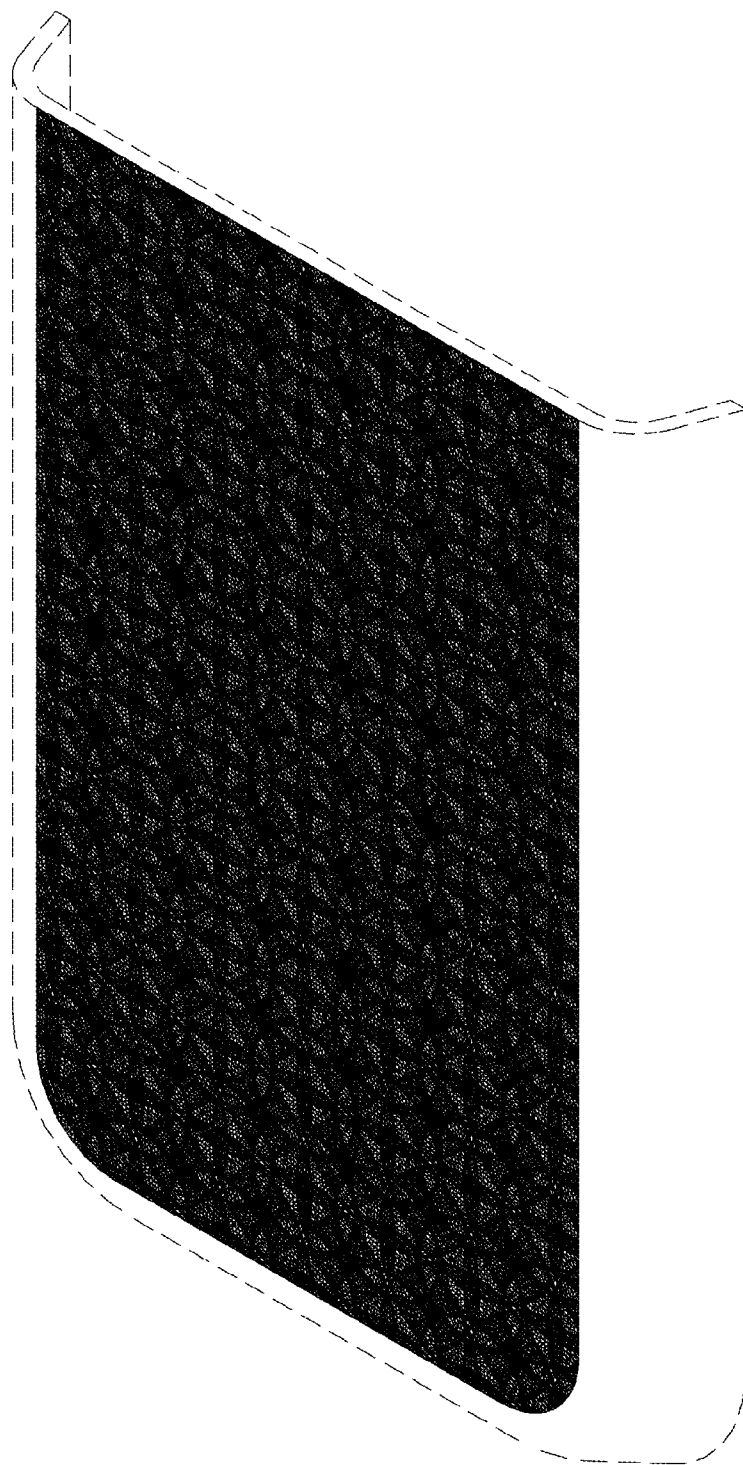


FIG. 1

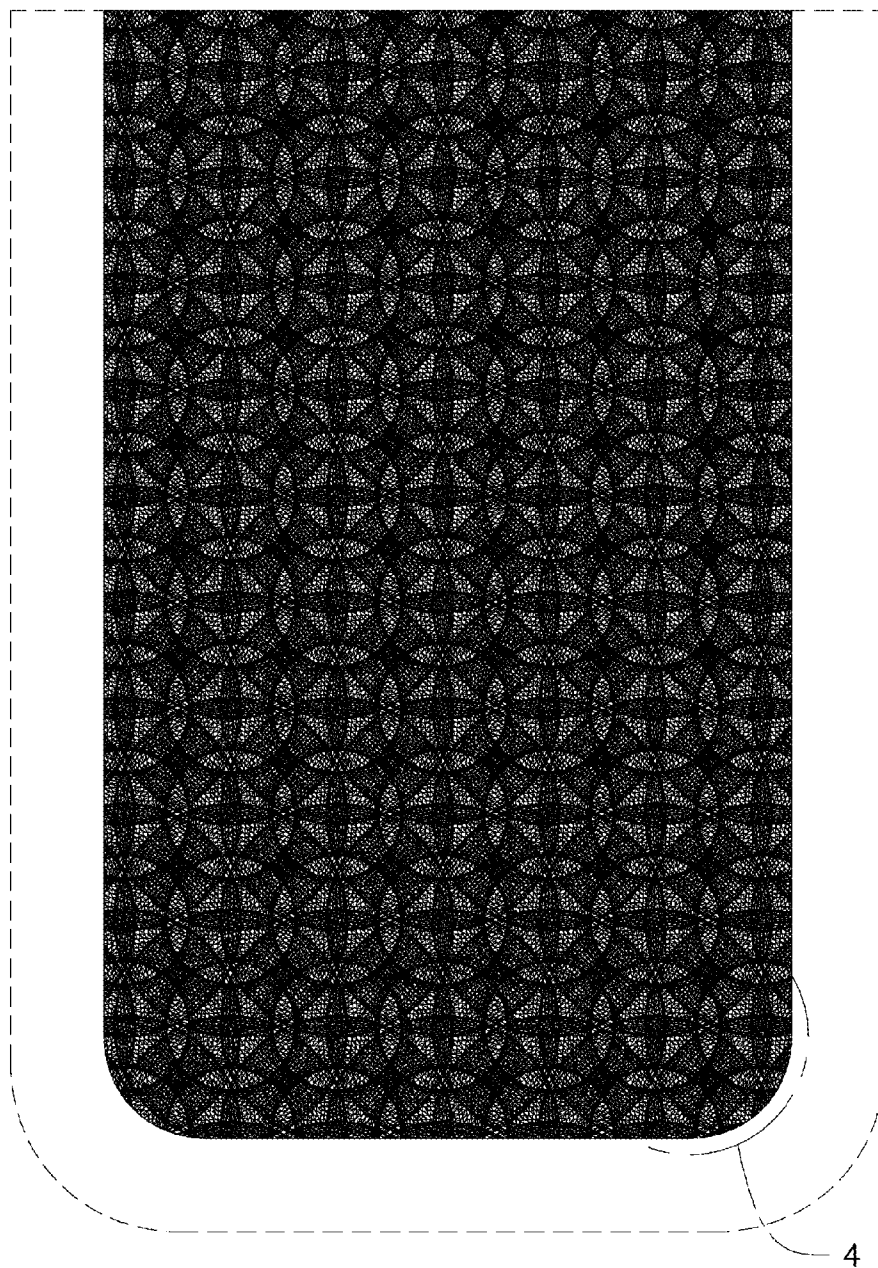


FIG. 2



FIG. 3

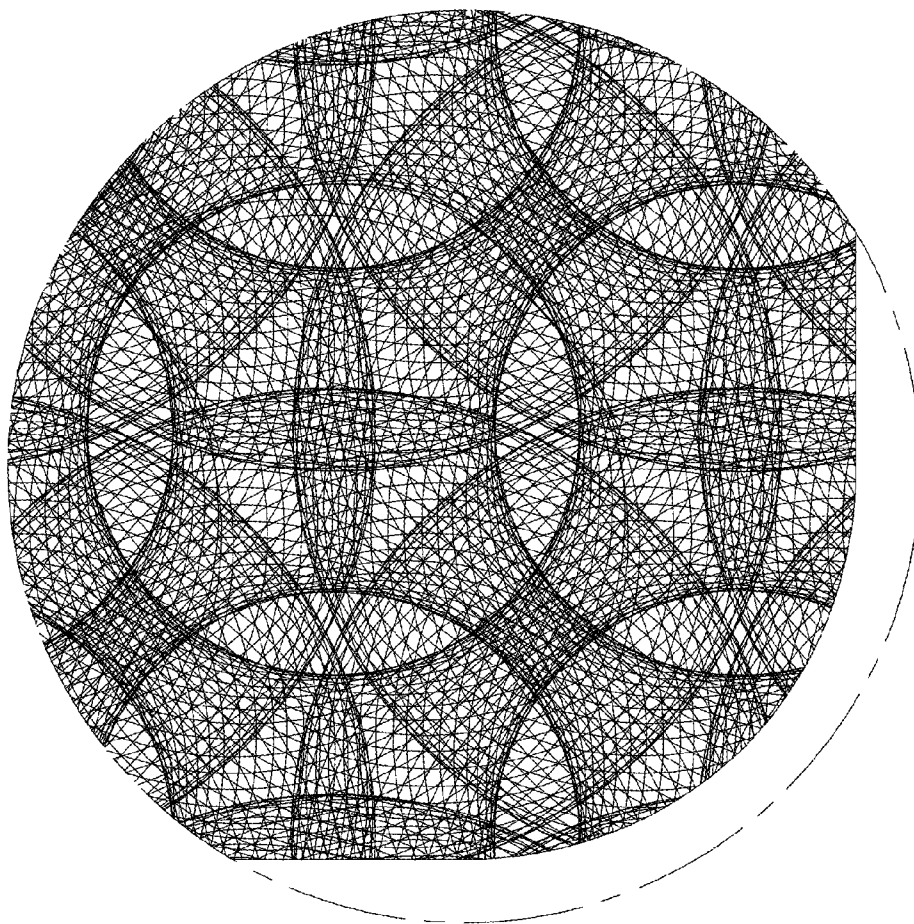


FIG. 4